

Docket No.:

2000 P 4162

THE BOUNK I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231. first class mail in

Date: August 3, 2001

JNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Knut Kahlisch et al.

Appl. No.

09/901,550

Filed

July 9, 2001

Title

Support Matrix with Bonding Channel for Integrated Semiconductors,

and Method for Producing It

Art Unit

LETTER

Hon. Commissioner of Patents and Trademarks, Washington, D.C. 20231

Sir:

The above-mentioned new patent application was filed on July 9, 2001 without a signed oath or declaration, under the provision of 37 C.F.R. 1.53(f).

In accordance with the above-mentioned rule, enclosed herewith is the original signed declaration.

The undersigned hereby states that the application filed in the Patent and Trademark Office is the application which the inventor(s) executed by signing the declaration. 601.01(a).

The fee required for the late filing of an oath or declaration in the amount of \$130.00 is also enclosed

Respectfully submitted,

GREGORYAL. MAYBACK

REØ NO. 40,719

mjb

Date: August 3, 2001

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